

### General Description

This Trench MOSFET has better characteristics, such as fast switching time, low on resistance, low gate charge and excellent avalanche characteristics. It is mainly suitable for DC/DC Converter, Synchronous Rectification and a load switch in battery powered applications

### FEATURES

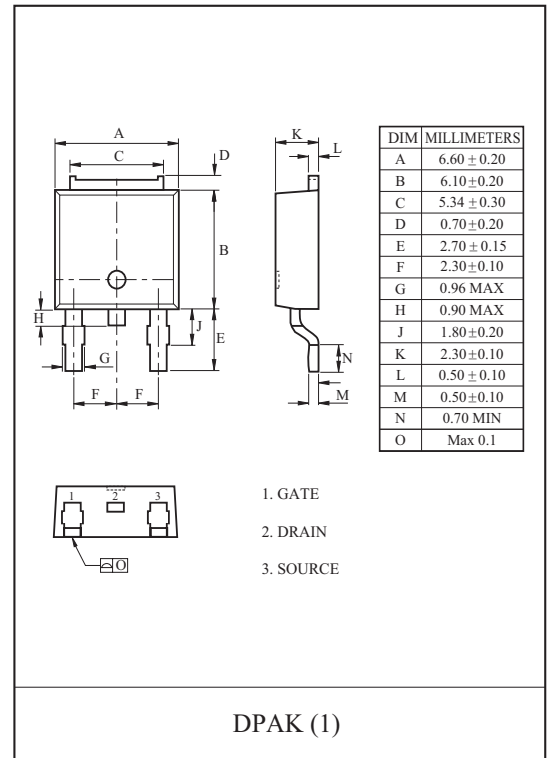
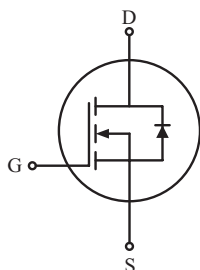
- $V_{DSS} = 100V$ ,  $I_D = 63A$
- Drain-Source ON Resistance :  
 $R_{DS(ON)} = 8.6m$  (Max.) @  $V_{GS} = 10V$

### MAXIMUM RATING (Tc=25 °C)

CHARACTERISTIC		SYMBOL	RATING	UNIT
Drain-Source Voltage		$V_{DSS}$	100	V
Gate-Source Voltage		$V_{GSS}$	$\pm 20$	V
Drain Current	@T <sub>c</sub> =25	$I_D$	63	A
	@T <sub>c</sub> =100		39	
	Pulsed (Note1)	$I_{DP}$	252*	
Single Pulsed Avalanche Energy (Note 2)		$E_{AS}$	125	mJ
Repetitive Avalanche Energy (Note 1)		$E_{AR}$	3.7	mJ
Peak Diode Recovery dv/dt (Note 3)		dv/dt	4.5	V/ns
Drain Power Dissipation	T <sub>c</sub> =25	$P_D$	62.5	W
	Derate above 25		0.5	W/
Maximum Junction Temperature		$T_j$	150	
Storage Temperature Range		$T_{stg}$	-55 ~ 150	
<b>Thermal Characteristics</b>				
Thermal Resistance, Junction-to-Case		$R_{thJC}$	2.0	/W
Thermal Resistance, Junction-to-Ambient		$R_{thJA}$	110	/W

\* : Drain current limited by maximum junction temperature.

### PIN CONNECTION



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## ELECTRICAL CHARACTERISTICS (Tc=25 )

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
<b>Static</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$I_D=250\ \mu A, V_{GS}=0V$	100	-	-	V
Breakdown Voltage Temperature Coefficient	$BV_{DSS}/T_j$	$I_D=250\ \mu A$ , Referenced to 25	-	0.05	-	V/
Drain Cut-off Current	$I_{DSS}$	$V_{DS}=100V, V_{GS}=0V$ ,	-	-	10	$\mu A$
Gate Threshold Voltage	$V_{th}$	$V_{DS}=V_{GS}, I_D=250\ \mu A$	2.0	-	4.0	V
Gate Leakage Current	$I_{GSS}$	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	$\pm 100$	nA
Drain-Source ON Resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=31.5A$	-	6	8.6	m
		$V_{GS}=6V, I_D=16A$	-	-	12	
<b>Dynamic</b>						
Total Gate Charge	$Q_g$	$V_{DS}=80V, I_D=63A$ $V_{GS}=10V$ (Note4,5)	-	53	-	nC
Gate-Source Charge	$Q_{gs}$		-	13	-	
Gate-Drain Charge	$Q_{gd}$		-	14	-	
Turn-on Delay time	$t_{d(on)}$	$V_{DD}=50V$ $I_D=63A$ $R_G=25$ (Note4,5)	-	45	-	ns
Turn-on Rise time	$t_r$		-	36	-	
Turn-off Delay time	$t_{d(off)}$		-	138	-	
Turn-off Fall time	$t_f$		-	46	-	
Input Capacitance	$C_{iss}$	$V_{DS}=25V, V_{GS}=0V, f=1.0MHz$	-	3100	-	pF
Output Capacitance	$C_{oss}$		-	1220	-	
Reverse Transfer Capacitance	$C_{rss}$		-	52	-	
<b>Source-Drain Diode Ratings</b>						
Continuous Source Current	$I_S$	$V_{GS}<V_{th}$	-	-	44	A
Pulsed Source Current	$I_{SP}$		-	-	176	
Diode Forward Voltage	$V_{SD}$	$I_S=44A, V_{GS}=0V$	-	-	1.4	V
Reverse Recovery Time	$t_{rr}$	$I_S=44A, V_{GS}=0V$ , $dI_S/dt=300A/\mu s$	-	65	-	ns
Reverse Recovery Charge	$Q_{rr}$		-	0.36	-	$\mu C$

Note 1) Repetivity rating : Pulse width limited by junction temperature.

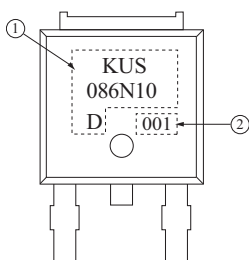
Note 2)  $L=22.7\ \mu H, I_S=63A, V_{DD}=80V, R_G=25$  , Starting  $T_j=25$  .

Note 3)  $I_S=44A, dI/dt=300A/\mu s, V_{DD}=BV_{DSS}$ , Starting  $T_j=25$  .

Note 4) Pulse Test : Pulse width  $300\ \mu s$ , Duty Cycle 2%.

Note 5) Essentially independent of operating temperature.

## Marking



① PRODUCT NAME

② LOT NO

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Fig1.  $I_D - V_{DS}$

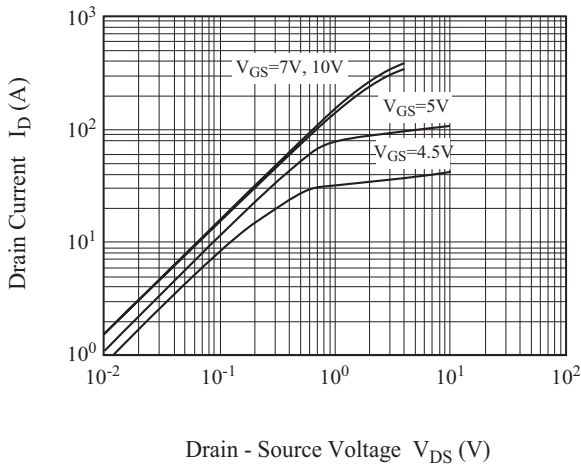


Fig2.  $I_D - V_{GS}$

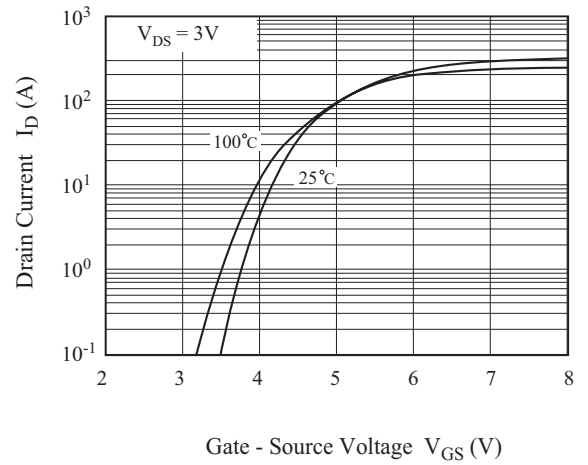


Fig3.  $BV_{DSS} - T_j$

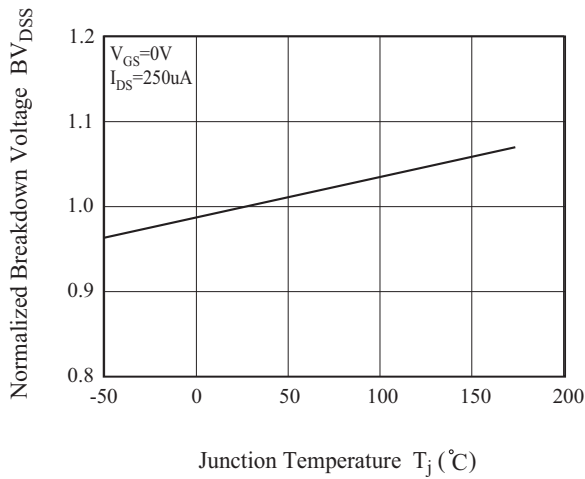


Fig4.  $R_{DS(ON)} - T_j$

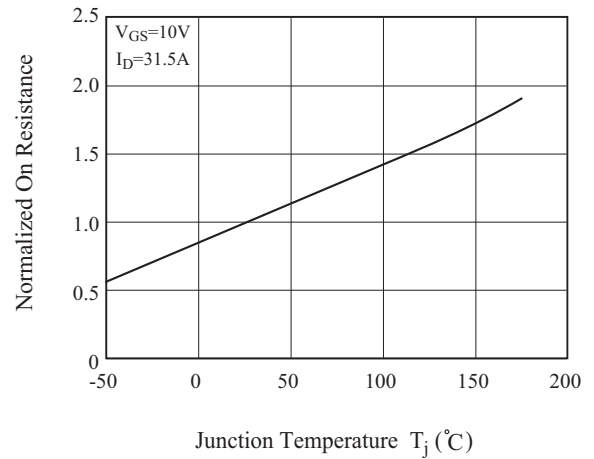


Fig5.  $I_S - V_{SD} - I$

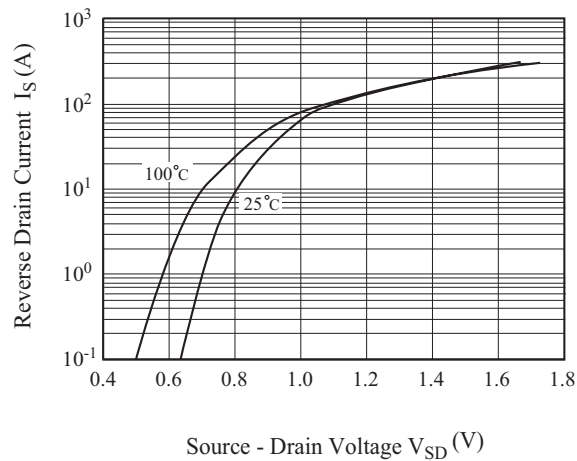
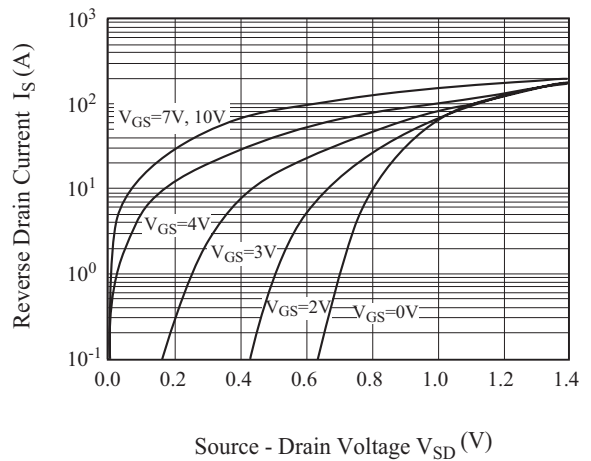


Fig6.  $I_S - V_{SD} - II$



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Fig7.  $R_{DS(ON)} - I_D$

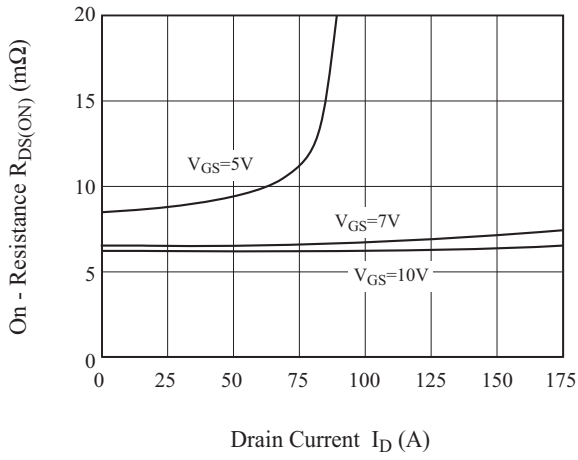


Fig8.  $V_{th} - T_j$

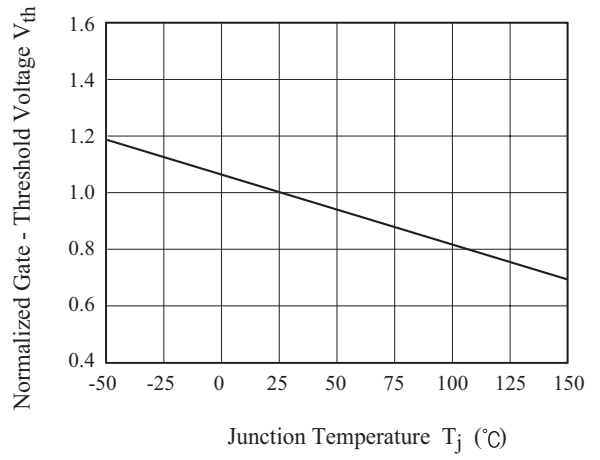


Fig 9. C -  $V_{DS}$

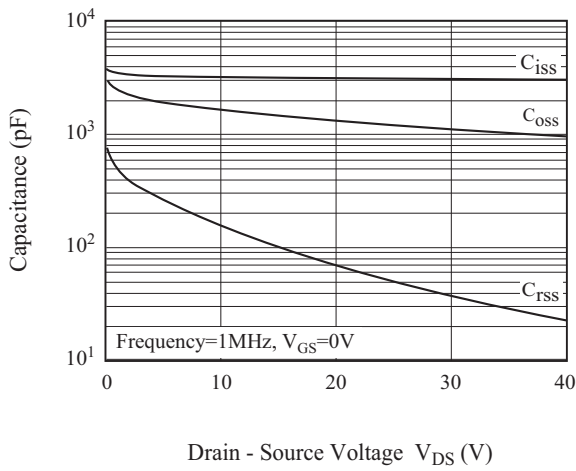


Fig10.  $Q_g - V_{GS}$

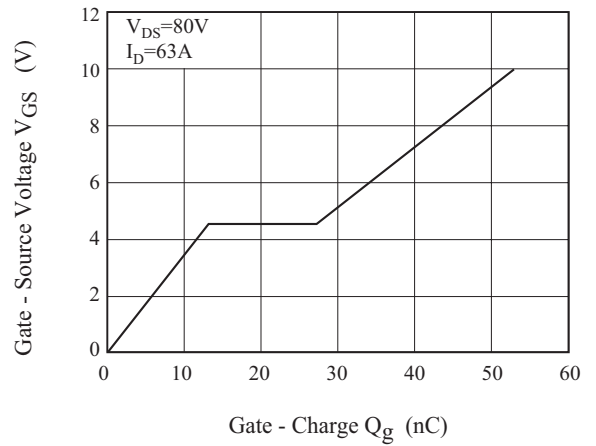


Fig11.  $I_D - T_j$

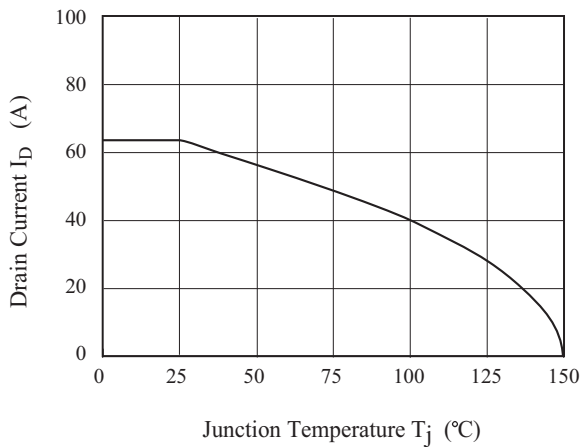
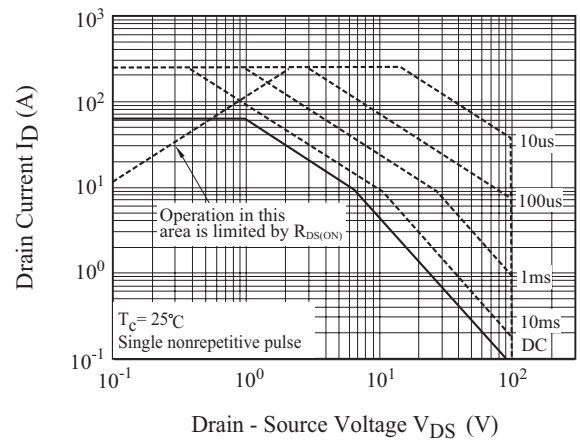


Fig12. Safe Operation Area



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Fig13. Transient Thermal Response Curve

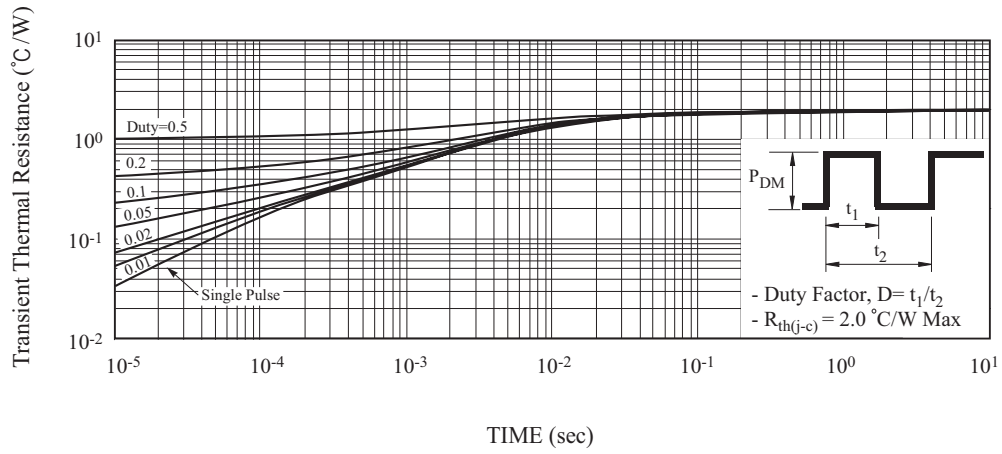


Fig14. Gate Charge

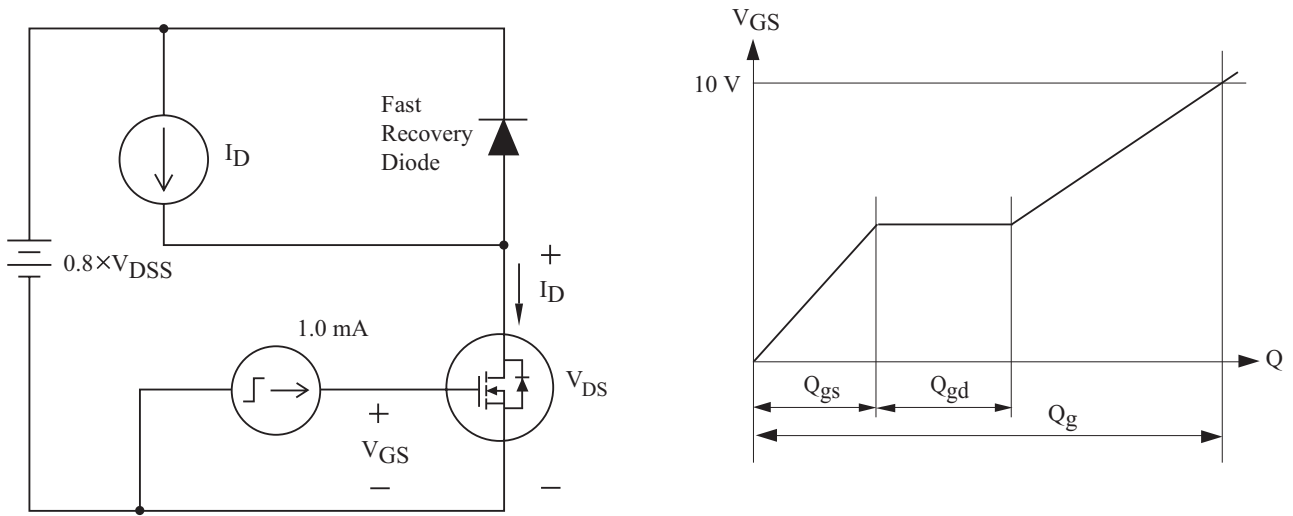


Fig15. Single Pulsed Avalanche Energy

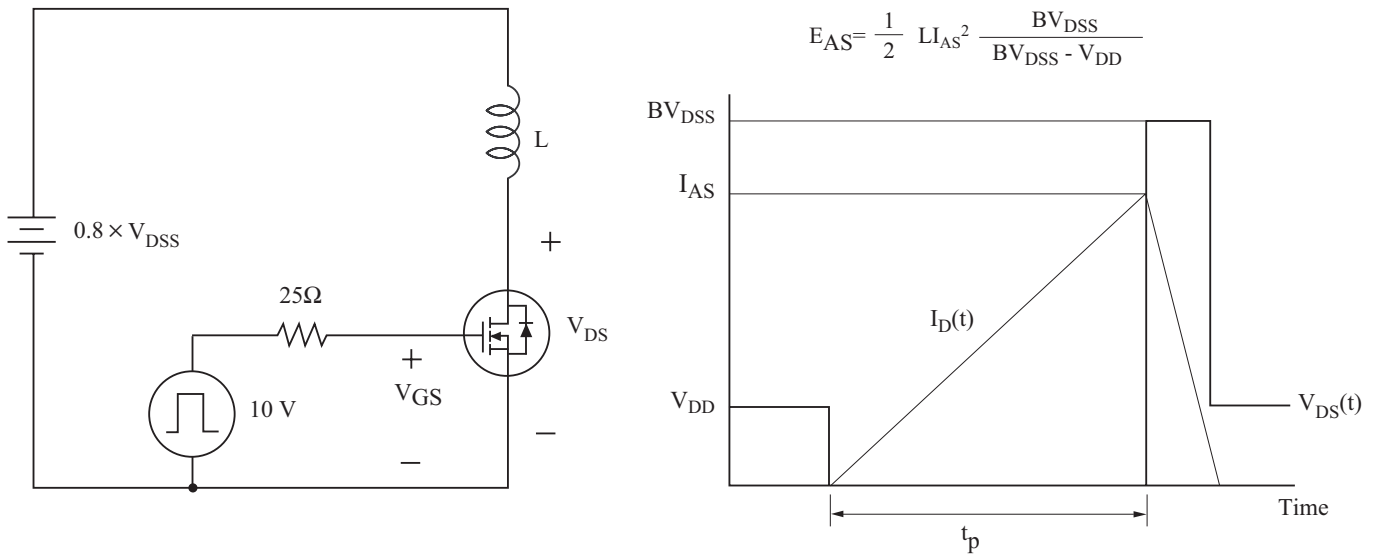


Fig16. Resistive Load Switching

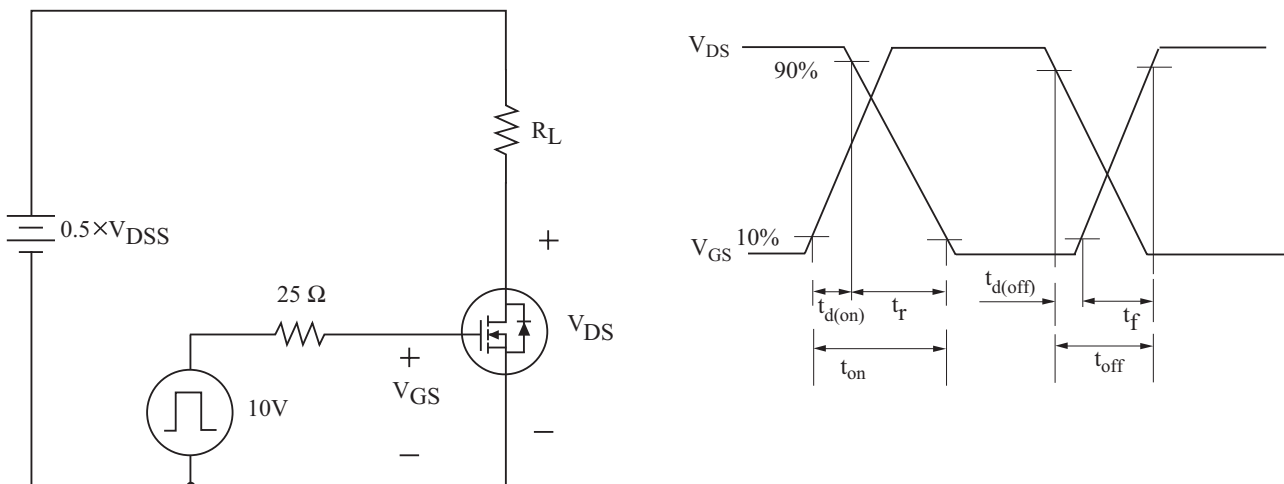


Fig17. Source - Drain Diode Reverse Recovery and  $dv/dt$

